Surface Mount

RF Transformer

TX1.5-1+

50Ω 0.25 to 300 MHz

Generic photo used for illustration purposes only

CASE STYLE: TT240

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Maximum Ratings

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

PRIMARY DOT	4
PRIMARY	6
SECONDARY DOT	3
SECONDARY	1
NOT USED	2,5

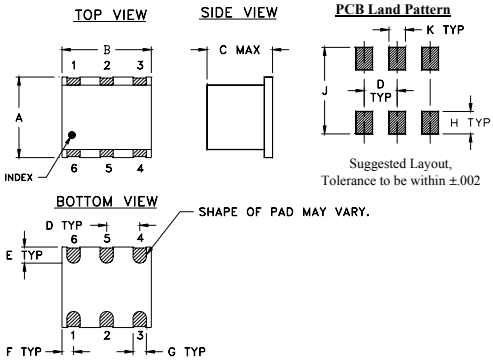
Features

- wideband, 0.25 to 300 MHz
- excellent return loss

Applications

- impedance matching
- VHF/UHF
- receivers/transmitters

Outline Drawing

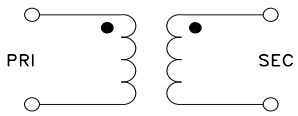


Outline Dimensions (inch / mm)

A	B	C	D	E	F
.250	.31	.20	.100	.050	.055
6.35	7.87	5.08	2.54	1.27	1.40

G	H	J	K	wt
.040	.070	.270	.050	grams
1.02	1.78	6.86	1.27	0.50

Config. C



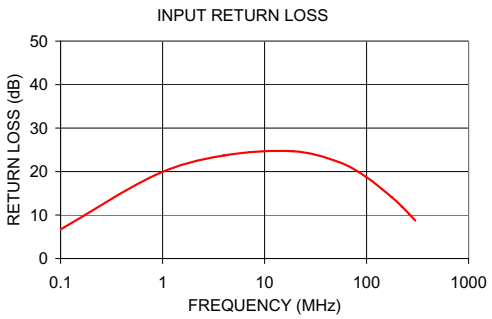
Transformer Electrical Specifications

Ω RATIO	FREQUENCY (MHz)	INSERTION LOSS*		
		3 dB MHz	2 dB MHz	1 dB MHz
1.5	0.25-300	0.25-300	0.3-150	0.5-80

* Insertion Loss is referenced to mid-band loss, 0.4 dB typ.

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.10	1.96	6.70
0.85	0.64	19.19
4.00	0.38	23.71
18.93	0.36	24.68
53.35	0.42	22.20
99.34	0.61	18.74
175.64	0.89	14.16
223.68	0.96	11.88
261.29	1.03	10.26
300.00	1.19	8.75



Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

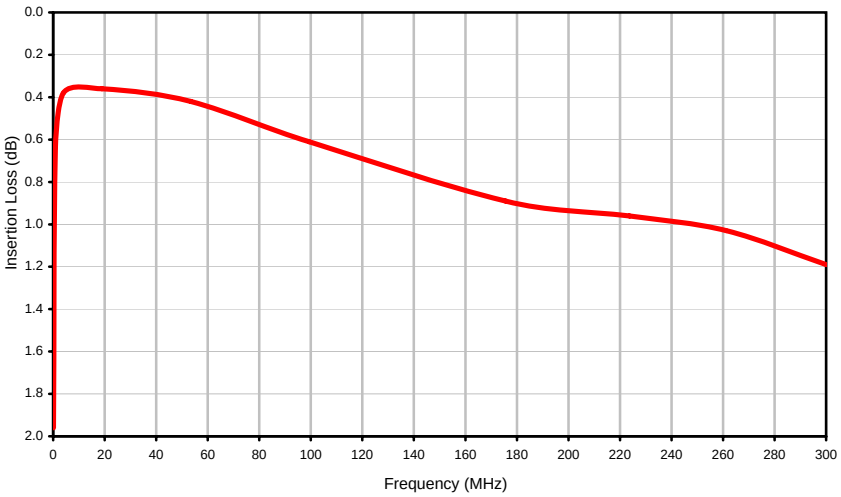
RF Transformer TX1.5-1+

Typical Performance Data

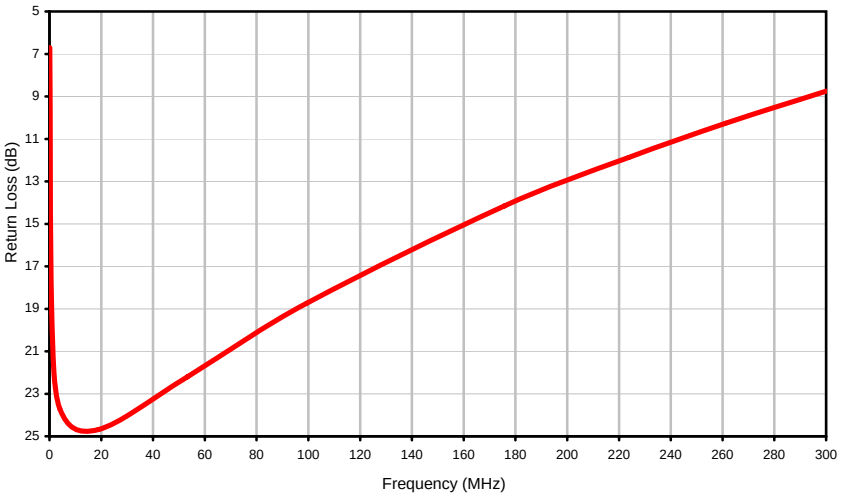
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.10	1.96	6.70
0.85	0.64	19.19
4.00	0.38	23.71
18.93	0.36	24.68
53.35	0.42	22.20
99.34	0.61	18.74
175.64	0.89	14.16
223.68	0.96	11.88
261.29	1.03	10.26
300.00	1.19	8.75

Typical Performance Curves

Insertion Loss



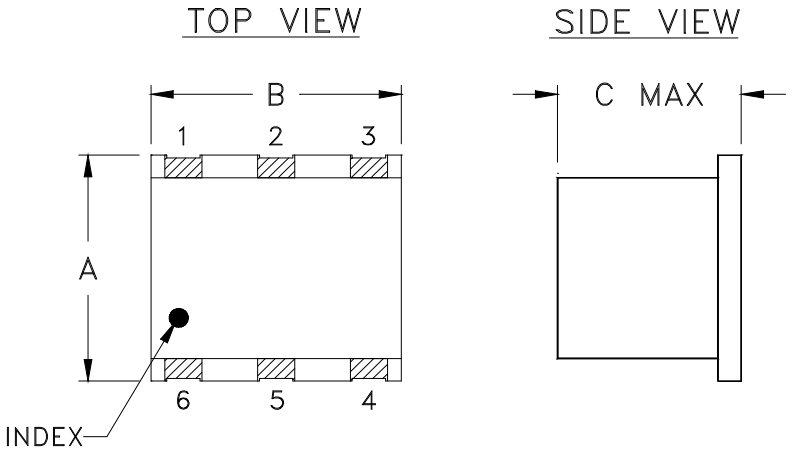
Return Loss

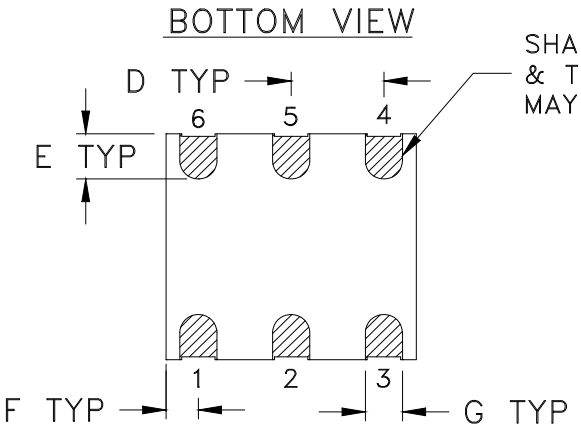


Case Style TT

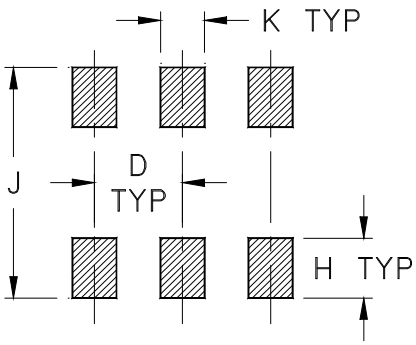
TT240

Outline Dimensions





PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

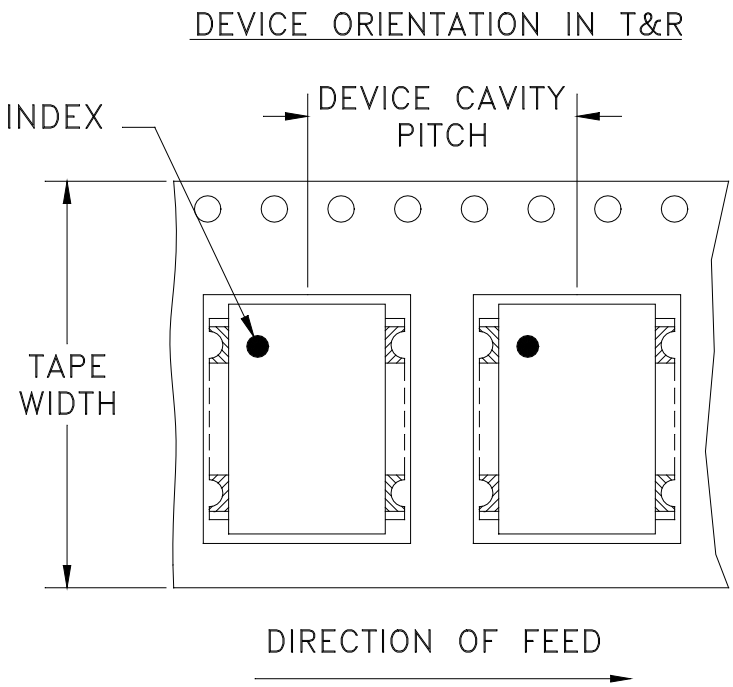
CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
TT240	.250 (6.35)	.31 (7.87)	.20 (5.08)	.100 (2.54)	.050 (1.27)	.055 (1.40)	.040 (1.02)	.070 (1.78)	.270 (6.86)	.050 (1.27)	.50

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

Notes:

1. Case material: Ceramic.
2. Termination finish:
   For RoHS Case Styles: 2-10µ inch (.05-.25 microns) Gold plate over 100-300 µ inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F2



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel See note
16	12	7	10
			20
			50
			100
			200
		13	500
			1000

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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Environmental Specifications ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215